

ON Semiconductor[®]

FGH75T65SHDT 650 V, 75 A Field Stop Trench IGBT

Features

- Maximum Junction Temperature: T_J = 175^oC
- Positive Temperature Co-efficient for Easy Parallel Operating •
- High Current Capability •
- Low Saturation Voltage: $V_{CE(sat)}$ = 1.6 V(Typ.) @ I_C = 75 A
- 100% of the Parts Tested for $I_{LM}(1)$
- High Input Impedance
- · Fast Switching
- Tighten Parameter Distribution •
- **RoHS** Compliant

General Description

Using novel field stop IGBT technology, ON Semiconductor's new series of field stop 3rd generation IGBTs offer the optimum performance for solar inverter, UPS, welder, telecom, ESS and PFC applica-tions where low conduction and switching losses are essential.

Applications

• Solar Inverter, UPS, Welder, Telecom, ESS, PFC





Absolute Maximum Ratings T_C = 25°C unless otherwise noted

Symbol	Description		FGH75T65SHDT-F155	Unit
V _{CES}	Collector to Emitter Voltage		650	V
N	Gate to Emitter Voltage		± 20	V
VGES	Transient Gate to Emitter Voltage		± 30	V
	Collector Current	@ T _C = 25 ^o C	150	A
	Collector Current	@ T _C = 100°C	75	A
I _{LM (1)}	Pulsed Collector Current	@ T _C = 25 ^o C	225	A
I _{CM (2)}	Pulsed Collector Current		225	A
le.	Diode Forward Current	@ T _C = 25 ^o C	125	A
	Diode Forward Current	@ T _C = 100 ^o C	75	A
I _{FM (2)}	Pulsed Diode Maximum Forward Currer	it	225	A
Po	Maximum Power Dissipation	@ T _C = 25 ^o C	455	W
. D	Maximum Power Dissipation	@ T _C = 100 ^o C	227	W
TJ	Operating Junction Temperature		-55 to +175	°C
T _{stg}	Storage Temperature Range		-55 to +175	°C
TL	Maximum Lead Temp. for soldering Purposes, 1/8" from case for 5 seconds		300	°C

2. Repetitive rating: Pulse width limited by max. junction temperature

Publication Order Number: FGH75T65SHDT-F155/D

Notes: 1. V_{CC} = 400 V, V_{GE} = 15 V, I_C = 225 A, R_G = 20 $\Omega_{\!\!},$ Inductive Load

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650 V, 75
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Therma	l Charac	teristics										
Symbol Paramete				r FGH7		GH75	75T65SHDT-F155				Unit	
R _{0JC} (IGBT)	GBT) Thermal Resistance, Junction to Ca			se, Max.			0.33			°C/W		
$R_{\theta JC}$ (Diode	$R_{\theta JC}(Diode)$ Thermal Resistance, Junction to Ca			ise, Ma	se, Max.			0.65			°C/W	
$R_{\theta JA}$ Thermal Resistance, Junction to Am				nbient,	Max.			40			(°C/W
Packag	e Markin	g and Order	ing In	forn	nation							
Part N	lumber	Top Mark	Pack	age	Packing Meth	nod	Ree	Size	Tape Wi	dth	Qı	uantity
FGH75T65	SHDT-155	FGH75T65SHDT	TO-247	7 G03	Tube			-	-			30
Electric	al Chara	cteristics of	the IC	GBT	T _C = 25°C unless othe	rwise r	noted					
Symbol		Parameter			Test Conditio	ons		Min.	Тур.	Ма	х.	Unit
Off Charac	teristics											
BV _{CES}	Collector to	Emitter Breakdown	Voltage	V _{GE} :	= 0V, I _C = 1 mA			650	-	-		V
ΔBV _{CES} / ΔT _J	Temperatur Voltage	e Coefficient of Brea	akdown	I _C = 1	I mA, Reference to	0 25 ⁰ (c	-	0.6	-		V/ºC
I _{CES}	Collector Cu	ut-Off Current		V _{CE} =	= V _{CES} , V _{GE} = 0 V			-	-	25	0	μA
I _{GES}	G-E Leakag	ge Current		V _{GE} :	= V _{GES} , V _{CE} = 0 V			-	-	±40	00	nA
On Charac	teristics			•			ľ					
V _{GE(th)}	G-E Thresh	old Voltage		I _C = 7	75 mA, V _{CE} = V _{GE}			4.0	5.5	7.	5	V
02(0)				I _C = 7	75 A, V _{GE} = 15 V			-	1.6	2.	1	V
V _{CE(sat)}	Collector to	ollector to Emitter Saturation Voltage		$I_{C} = 75 \text{ A}, V_{GE} = 15 \text{ V},$ $T_{C} = 175^{\circ}\text{C}$				-	2.28	-		V
Dynamic C	haracteristic	cs										
C _{ies}	Input Capac	citance						-	3680	-		pF
C _{oes}	Input Capacitance Output Capacitance Reverse Transfer Capacitance		$V_{CE} = 30 V_{V_{GE}} = 0 V_{H}$			-	179	-		pF		
C _{res}	Reverse Tra	Thermal Resistance, Junction to A Marking and Ordering I mber Top Mark Pac IDT-155 FGH75T65SHDT TO-24 I Characteristics of the Parameter ristics Collector to Emitter Breakdown Voltage Collector Cut-Off Current Set Leakage Current Set Leakage Current Set Threshold Voltage Collector to Emitter Saturation Voltage Set Transfer Capacitance Control Delay Time Set Time Turn-On Delay Time Set Time Turn-On Switching Loss Set Time Turn-Off Delay Time Set Time			VITIZ		_	-	43			pF
Switching	Characterist	ics										
t _{d(on)}	Turn-On De	lay Time		[-	28	-		ns
t _r	Rise Time	-		-			-	-	61	-		ns
t _{d(off)}	Turn-Off De	lay Time		Vcc	= 400 V. Ic = 75 A.		F	-	86	-		ns
t _f	Fall Time			$R_G =$	3Ω , V _{GE} = 15 V,	• -	F	-	16	-		ns
Eon	Turn-On Sw	vitching Loss		Induc	tive Load, T _C = 25	°C	_	-	3	-		mJ
E _{off}	Turn-Off Sw	vitching Loss		1			F	-	0.75	-		mJ
E _{ts}	Total Switch	ing Loss		1			F	-	3.75	-		mJ
t _{d(on)}	Turn-On De	lay Time						-	27	-		ns
t _r	Rise Time			1			F	-	62	-		ns
t _{d(off)}	Turn-Off De	lay Time		V _{CC} =	= 400 V, I _C = 75 A,			-	93	-		ns
t _f	Fall Time			R _G =	3Ω , V _{GE} = 15 V,	F ⁰ C		-	16	-		ns
Eon	Turn-On Sw	vitching Loss		mauc	uve Load, 1 _C = 1/	50		-	4.7	-		mJ
E _{off}	Turn-Off Sw	vitching Loss						-	1.03	-		mJ
E _{ts}	Total Switch	ning Loss						-	5.73	-		mJ

Electrical Characteristics of the IGBT (Continued)

Symbol	Parameter	Test Conditions	Min.	Тур.	Max	Unit
Qg	Total Gate Charge	V _{CE} = 400 V, I _C = 75 A, V _{GE} = 15 V	-	123	-	nC
Q _{ge}	Gate to Emitter Charge		-	22.6	-	nC
Q _{gc}	Gate to Collector Charge		-	44.9	-	nC

Electrical Characteristics of the Diode T_C = 25°C unless otherwise noted

Symbol	Parameter	Test Condition	Min.	Тур.	Max	Unit	
Ven	Diode Forward Voltage	In = 75 A	T _C = 25°C	-	1.8	2.1	V
*FM			T _C = 175 ^o C	-	1.7	-	
E _{rec}	Reverse Recovery Energy		T _C = 175 ^o C	-	160	-	uJ
t	Diode Reverse Recovery Time	I _F =75 A, dI _F /dt = 200 A/μs	T _C = 25°C	-	76	-	ns
۲r			T _C = 175 ^o C	-	270	-	
0	Diode Reverse Recovery Charge		T _C = 25 ^o C	-	206	-	nC
			T _C = 175 ^o C	-	2199	-	

FGH75T65SHDT — 650 V, 75 A Field Stop Trench IGBT

Typical Performance Characteristics Figure 1. Typical Output Characteristics 225 ·15V $T_C = 25^{\circ}C$ 20V 200 .12V Collector Current, Ic [A] ν 10/ 150 V_{GE} = 8V 100 50 0 1 2 3 4 5 Collector-Emitter Voltage, V_{CE} [V] 0 6 Figure 3. Typical Saturation Voltage Characteristics 225 Common Emitter 200 V_{GE} = 15V $T_{C} = 25^{\circ}C$ — Collector Current, I_c [A] T_C = 175^oC 150 100 50 0 0 2 3 5 4 Collector-Emitter Voltage, V_{CE} [V] Figure 5. Saturation Voltage vs. V_{GE} 20 Common Emitter Collector-Emitter Voltage, V_{CE} [V] $T_c = 25^{\circ}C$ 16 12 75A 8 I_C = 404 150A 4 0 ⊾ 4 8 12 16 20 Gate-Emitter Voltage, V_{GE} [V]

Figure 2. Typical Output Characteristics







Figure 6. Saturation Voltage vs. V_{GE}





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